## Capabilities

Category	Description	Capability
File Formats	Gerber files- preferred format	274-X,274-D, DPF, ODB++
	Drill file	X & Y coordinates, with tool sizes included
Size	Maximum finished dimensions	550mm x 700mm – Single/ Double-sided
	unnensions	550mm x 700mm - Multi-layer
	Standard	$1.6$ mm $\pm 10\% (0.062" \pm 10\%)$
Board Thickness	Minimum	Single- Double-sided: $0.2\text{mm} \pm 0.1\text{mm}$ ( $0.008$ " $\pm 0.004$ ")  4-layer: $0.4\text{mm} \pm 0.1\text{mm}$ ( $0.016$ " $\pm 0.004$ ")  6-layer: $0.6\text{mm} \pm 0.1\text{mm}$ ( $0.024$ " $\pm 0.004$ ")  8-Layer: $1.0\text{mm} \pm 0.1\text{mm}$ ( $0.040$ " $\pm 0.004$ ")  10-layer: $1.0\text{mm} \pm 0.12\text{mm}$ ( $0.040$ " $\pm 0.005$ ")  12-layer: $1.2\text{mm} \pm 0.12\text{mm}$ ( $0.048$ " $\pm 0.005$ ")   32-layer: $4.0\text{mm} \pm 0.4\text{mm}$ ( $0.157$ " $\pm 0.015$ ") and above
	Maximum	$6.3 \text{mm} \pm 10\% (0.248" \pm 10\%)$
	Bow and twist	< 7/1000
Copper Weight	Outer copper weight	1 oz (35um) ~ 10 oz (350um)
	Inner copper weight	1/3 oz (12um) ~ 6 oz (210um)
Laminate Materials	FR-4(High TG, halogen-free)、FR-5、ISOLA(FR408、370HR)、TEFLON、POLYIMIDE ROGERS(RO4003、RO4350、RO4450)、Aluminum plate (Single, Double-sided)	

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	FR4 Thickness (standard)	1.6mm (0.062")
	High TG FR4 (170 deg C) (standard)	1.6mm (0.062")
Board Cutting	Maximum number of layers	32 layers
	Minimum thickness for inner layers (copper thickness are excluded)	0.07mm (0.003")
	Minimum size	0.1mm (0.004")
	Maximum size	6.0mm
Drilling	Drill Deviation (True position size)	±0.002" (0.050mm)
	PTH hole tolerance	±0.003" (0.075mm)
	N-PTH hole tolerance	±0.002" (0.050mm)
	Angle of Countersink	80°、90°、100°、120°
	Minimum hole size	0.0008"
Plating	Aspect ratio	20
	Trace width tolerance	±20%
Etching	Minimum trace width / space (1 oz finished copper weight starting from 1/3 oz)	0.003"/ 0.003" (0.08mm)
	Minimum trace width / space (1 oz finished copper weight starting from 1/2 oz)	0.004"/ 0.004" (0.1mm)
	Minimum trace width / space (2 oz finished copper weight)	0.005"/ 0.005" (0.127mm)
	Minimum trace width / space (3 oz finished copper weight)	0.008"/ 0.008" (0.2mm)

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	Minimum trace width / space (4 oz finished copper weight)	0.012"/ 0.012" (0.3mm)
Inner Layers	Minimum space from drilling to inner pattern	0.004"(0.1mm)
	Minimum space from annular ring to inner pattern	0.004"(0.1mm)
	Layer-to-layer registration	±0.003"(0.08mm)
Solder Mask	Colour	Green, light green, matte green, white, extreme white, black, matte black, dark brown, yellow, red, blue, transparent.
	Minimum solder mask clearance	0.003"
	Thickness	0.0004"
	Colour	White, black, yellow, red, blue, green
Silkscreen	Minimum trace width	0.005"
	Minimum size	0.028" / 0.028"
Electrical	AOI	Yes
Test	Flying Probe Tester	Yes
Controlled Impedance	Tolerance	±10%
	Impedance tester	Tektronix TDS8200
Routing	End Mills Test	±0.15mm (0.006")
	CNC Tolerance	±0.15mm (0.006")
	V-Cut Depth (board thickness > =1.0mm)	±0.1mm (0.004")
	V-cut angle deviation	±0.1mm (0.004")
	Semi-hole	Yes

Category	Description	Capability
Surface Finish	HASL, HASL pb free, immersion gold, immersion silver, immersion tin, O.S.P (Entek), S/G plating, ENEPIG, G/F plating, carbon	
Blind and Buried Vias	3+N+3	Yes
	Resin, hole-filling ink, Plating through hole	Yes
Others	UL Certification	Yes
	ISO Certification	ISO9001/ISO14001/RoHS